Low Capacitance ESD Protection Device

Features

□ Transient protection for high-speed data lines

IEC 61000-4-2 (ESD) ±27kV (Air)

±17kV (Contact)

IEC 61000-4-4 (EFT) 40A (5/50 ns) Cable Discharge Event (CDE)

- □ Small package (2.9mm x 2.8mm x 1.4mm)
- Protects four data lines
- □ Low capacitance: 0.7pF Typical (I/O-GND)
- □ Low leakage current: 0.1uA@V_{RWM} (Typical)
- □ Low clamping voltage
- □ Each I/O pin can withstand over 1000 ESD strikes for ±8kV contact discharge
- □ Green part

Description

T0514VL is an ultra-low capacitance Transient Voltage Suppressor (TVS) designed to provide electrostatic discharge (ESD) protection for high-speed data interfaces. With typical capacitance of 0.7pF only, T0514VL is designed to protect parasitic -sensitive system against over-voltage and over-current transient events. It complies with IEC61000-4-2(ESD) ,Level 4 (±15kV air,±8kV contact discharge),IEC 61000-4-4 (electrical fast transient - EFT) (40A,5/50ns) , very fast charged divice model (CDM)ESD and cable discharge event (CBE),etc.

T0514VL user SOT23-6L package. Each T0514VL device can protect four high-speed data lines. The combined features of low capacitance, small size and high ESD robustness make T0514VL ideal for high-speed data ports and high-frequency lines (e.g., HDMI & DVI) applications. The low clamping voltage of the T0514VL guarantees a minimum stress on the protected IC.

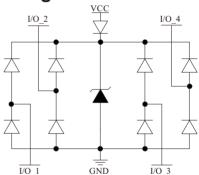
Applications

- □ Video Graphics Cards
- □ Desktops, Servers and Notebooks
- □ IEEE 1394 Ports
- □ USB 2.0/3.0 Power and Data Line Protection
- Display Ports
- □ SIM Ports

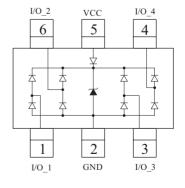
Mechanical Characteristics

- □ SOT23-6L package
- □ Flammability Rating: UL 94V-0
- □ Marking: Part number
- □ Packaging: Tape and Reel

Circuit Diagram



Pin Configuration



SOT23-6L (Top View)

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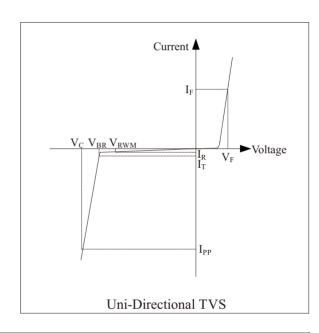


Absolute Maximum Rating

Symbol	Parameter	Value	Units
V	ESD per IEC 61000-4-2 (Air)	±27	kV
$ m V_{ESD}$	ESD per IEC 61000-4-2 (Contact)	±17	K V
T_{OPT}	Operating Temperature	-55/+125	°C
T_{STG}	Storage Temperature	-55/+150	°C

Electrical Characteristics (T = 25 °C)

Symbol	Parameter
V_{RWM}	Nominal Reverse Working Voltage
I_R	Reverse Leakage Current @ V _{RWM}
V_{BR}	Reverse Breakdown Voltage @ I _T
I_T	Test Current for Reverse Breakdown
V_{C}	Clamping Voltage @ I _{PP}
I_{PP}	Maximum Peak Pulse Current
C_{ESD}	Parasitic Capacitance
V_R	Reverse Voltage
f	Small Signal Frequency
I_{F}	Forward Current
V_{F}	Forward Voltage @ I _F

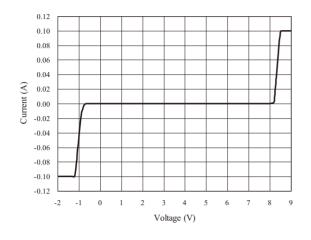


Symbol	Test Condition	Minimum	Typical	Maximum	Units
V_{RWM}				5.0	V
I_R	V _{RWM} = 5V, T = 25 °C Between I/O and GND		0.1	1.0	μA
V_{BR}	$I_T = 1 \text{mA}$ Between I/O and GND	6.0	8.0	10.0	V
$V_{\rm C}$	$I_{PP} = 1A$, $t_p = 8/20 \mu s$ Between I/O and GND			12.0	V
C_{ESD}	$V_R = 0V$, $f = 1MHz$ Between I/O and GND		0.7	0.8	pF
C_{ESD}	$V_R = 0V$, $f = 1MHz$ Between I/O and I/O		0.35		pF

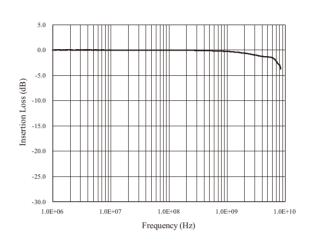
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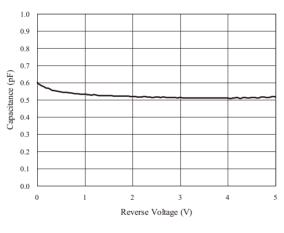


Insertion Loss S21 of I/O to GND

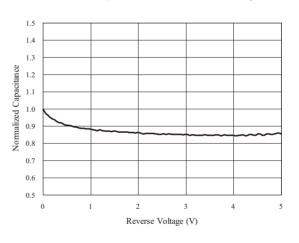


Capacitance vs. Voltage of I/O to GND (f = 1MHz)

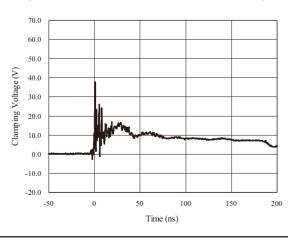
Capacitance vs. Reverse Voltage



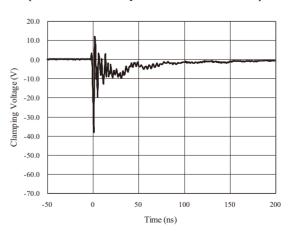
Normalized Capacitance vs. Reverse Voltage



ESD Clamping of I/O to GND (+8kV Contact per IEC 61000-4-2)



ESD Clamping of I/O to GND (-8kV Contact per IEC 61000-4-2)



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Chip Integration Technology Corporation

Application Information

Pin Connection in PCB

T0514VL is capable to provide ESD protection for four data lines simultaneously. The pin connection is shown in Figure 1.

Four parallel data lines, from inner IC to I/O port connector, could connect to T0514VL four I/O pins directly. Pin 2 of T0514VL is the negative reference pin, which should connect to the GND of PCB. The connection wires should be as short as possible in order to minimize the parasitic inductance.

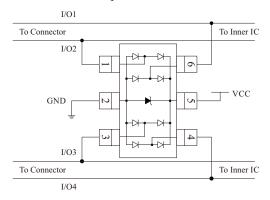


Figure 1 T0514VL pin connection in PCB

PCB Layout Guidelines

For optimum ESD protection and the whole circuit performance, the following PCB layout guidelines are recommended:

- T0514VL GND pin to the PCB GND rail path should be as short as possible. It could reduce the ESD transient return path to GND.
- The vias connecting T0514VL VCC & GND pins to the PCB VCC & GND should be wide.
- Place T0514VL as close to the connector port as possible. It could reduce the parasitic inductance and restrict ESD coupling into adjacent traces.
- Avoid running critical signals near board edges.

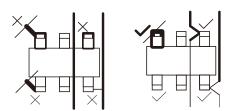
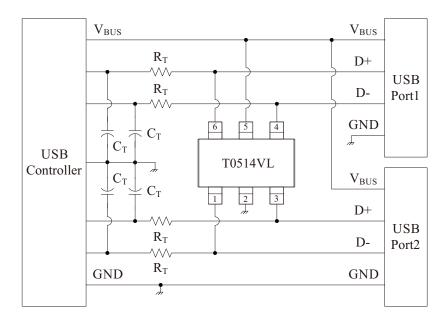


Figure 2 T0514VL Layout Guideline

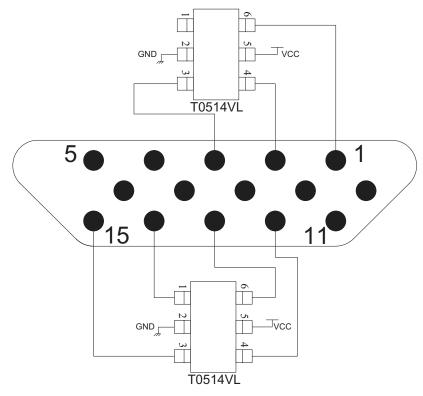
Universal Serial Bus ESD Protection



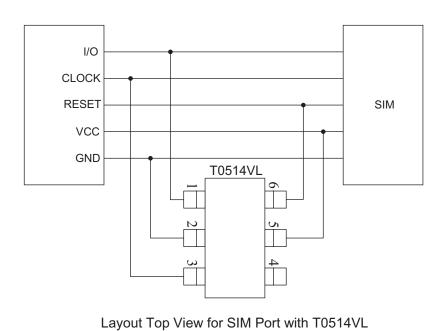
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Low Capacitance ESD Protection Device

Application Information (continued)



Layout Top View for Video (VGA) Interface with T0514VL

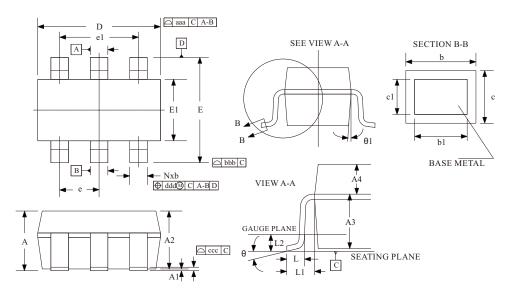


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Low Capacitance ESD Protection Device

Package Outline

SOT23-6L package



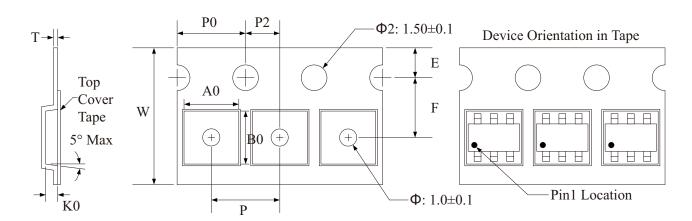
Package Dimensions (Controlling dimensions are in millimeters)

Cross la a l	D	imensions (mr	n)	Dir	mensions (Incl	nes)	
Symbol	Minimum	Typical	Maximum	Minimum	Typical	Maximum	
A	_	-	1.450			0.057	
A1	0.000		0.150	0.000		0.006	
A2	0.900	1.200	1.300	0.035	0.047	0.012	
A3	0.637	0.787	0.837	0.025	0.031	0.033	
A4	0.263	0.413	0.463	0.010	0.016	0.018	
b	0.300		0.500	0.012		0.020	
b1	0.300	0.400	0.450	0.012	0.016	0.018	
С	0.080		0.220	0.003		0.009	
c1	0.080	0.130	0.200	0.003	0.005	0.008	
D		2.90 BSC		0.114 BSC			
e		0.95 BSC		0.037 BSC			
e1		1.90 BSC		0.075 BSC			
Е		2.80 BSC		0.110 BSC			
E1		1.60 BSC		0.063 BSC			
L	0.300	0.450	0.600	0.012	0.018	0.024	
L1		0.600 REF			0.024 REF		
L2		0.250 BSC		0.010 BSC			
θ	0°	4°	8°	0°	4°	8°	
θ1	5°	10°	15°	5°	10°	15°	
aaa	0.150				0.006		
bbb	0.200			0.008			
ссс		0.100			0.004		
ddd		0.100			0.004		

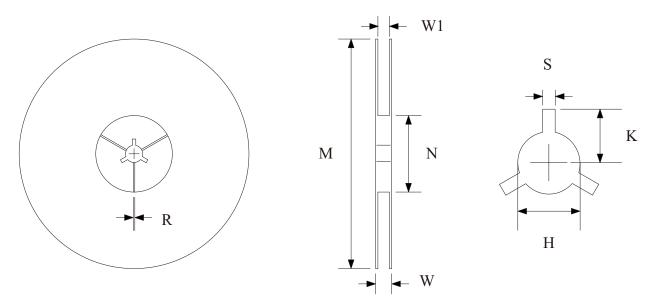
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Tape and Reel Specification



Symbol	W	A0	В0	K0	Е	F	P	P0	P2	Т
Dimensions (mm)	8.00+0.3 -0.1	3.23±0.05	3.17±0.05	1.37±0.05	1.75±0.1	3.5±0.05	4.0±0.1	4.0±0.1	2.0±0.05	0.25±0.02



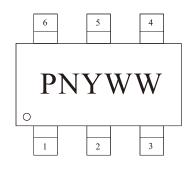
Symbol	Reel Size	M	N	W	W1	Н	S	K	R
Dimensions (mm)	Ф178	178.0±1.0	60.0±1.0	11.5±0.5	9.0±0.5	13.0±0.5	2.0±0.1	11.0±0.2	1.0±0.05

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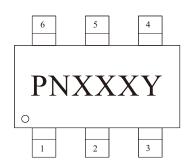


Low Capacitance ESD Protection Device

Marking Codes







Note:

- (1) PN is"16"or"6U", and is part number, fixed.
- (2) "YWW" is date code. "Y" is the assembly year (2012 is "2"); while "WW" is the assembly week in a year.

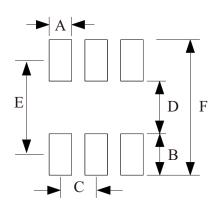
Note:

- (1) PN is"16"or"6U", and is part number, fixed.
- (2) "XXX" is the last 3 characters of the wafer's Lot No., "Y" is the internal code.

Ordering Information

Part Number	Working Voltage	Quantity Per Reel	Reel Size
T0514VL	5V	3,000	7 Inch

Footprint: SOT23-6L



C11	Dimensions				
Symbol	Millimeters	Inches			
A	0.60	0.024			
В	1.10	0.043			
С	0.95	0.037			
D	1.40	0.055			
Е	2.50	0.098			
F	3.60	0.141			

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